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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/521,248	04/11/2005	Hideharu Itatani	122430	9181
25944	7590	07/16/2008	EXAMINER	
OLIFF & BERRIDGE, PLC P.O. BOX 320850 ALEXANDRIA, VA 22320-4850			EVERHART, CARIDAD	
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary	Application No. 10/521,248	Applicant(s) ITATANI ET AL.
	Examiner Caridad M. Everhart	Art Unit 2891

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If no period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED. (35 U.S.C. § 133).

Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 30 June 2008.

2a) This action is FINAL. 2b) This action is non-final.

3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 16-19 is/are pending in the application.

4a) Of the above claim(s) _____ is/are withdrawn from consideration.

5) Claim(s) _____ is/are allowed.

6) Claim(s) 16-19 is/are rejected.

7) Claim(s) _____ is/are objected to.

8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.

10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.

Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).

Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).

11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).

a) All b) Some * c) None of:

1. Certified copies of the priority documents have been received.
2. Certified copies of the priority documents have been received in Application No. _____.
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO/SB/08)

Paper No(s)/Mail Date _____

4) Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____

5) Notice of Informal Patent Application

6) Other: _____

The indicated allowability of claims 16-19 is withdrawn in view of the newly discovered reference(s) to Matsuse et al (US 2002/0197856A1) and Lu et al (US 2002/0028578A1). Rejections based on the newly cited reference(s) follow.

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claim 18 rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 18 seems to be not consistent with claim 16 upon which claim 18 depends because claim 16 recites "initial metal film" and "main metal film" while claim 18 recites "or a RuO₂ film", and RuO₂ is not a metal.

Claim Rejections - 35 USC § 103

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 16-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Matsuse et al (US 2002/0197856A1) in view of Lu et al (US 2002/0028578A1).

Matsuse et al disclose the steps of forming a groove and a via opening in a dielectric layer(paragraph 0057), and then forming a WN_x film by ALD method including the steps of flowing W precursor and alternately flowing nitrogen and purging(paragraphs 0059 and 0060) . The temperature is 300-450 degrees C or may be 500 degrees C(paragraph 0061) and the pressure is 1-20 Torr(paragraphs 0061, 0071 and 0072). Thereafter a W layer is formed on the WN_x film by thermal CVD in the same apparatus with flow of N₂ gas(paragraphs 0071, 0072, and 0077 and 0078). The ALD processing is a plasma process, so that there are radicals involved(paragraphs 0065 and 0068 and 0072). The tungsten precursor may be WF₆ or may be hexacarbonyl tungsten(paragraphs 0060 and 0100 and 0101).

Matsuse et al is silent with respect to the same temperature for the thermal CVD layer.

Lu et al disclose that the thermal CVD layer in a process for a plasma CVD nucleation layer of W and a bulk thermal CVD layer of W is between 400-500 degrees C(paragraph 0025).

It would have been obvious to one of ordinary skill in the art at the time of the invention to have formed the thermal CVD layer taught by Matsuse et al at the same temperature as the ALD layer in view of the teaching of the temperature range for thermal CVD W made by Lu et al because Matsuse et al teach 300-450 degrees or 500 degrees C for the ALD layer and teach further that the thermal CVD W layer is formed successively in the same chamber, and the same temperature would in addition make the process have continuous without delay of changing the temperature.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Caridad M. Everhart whose telephone number is 571-272-1892. The examiner can normally be reached on Monday through Fridays 7:30-4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, B. Baumeister can be reached on 571-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Caridad Everhart/
Primary Examiner
AU 2891

7-10-2008